



MAS-FIN-128

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By: [Signature]

Date: June 12, 2003 #11/

2831 \$  
A  
D. EVANS  
6-27-03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Harry Hedler et al.  
Applic. No. : 10/056,356  
Filed : January 24, 2002  
Title : Electronic Component with a Semiconductor  
Chip and Method of Producing the Electronic  
Component  
Examiner : Hung V. Ngo  
Group Art Unit : 2831

A M E N D M E N T

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

S i r :

Responsive to the Office action dated March 12, 2003 kindly  
amend the above-identified application as follows:

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JUN 19 2003  
TECHNOLOGY CENTER 2800

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